TMC2490
Multistandard Digital Video Encoder

Features

- All-Digital Video Encoding
- Internal Digital Subcarrier Synthesizer
- 8-Bit Parallel CCIR-601/CCIR-656/ANSI/SMPTE 125M Input Format
- CCIR-624/SMPTE-170M Compliant Output
- Switchable Chrominance Bandwidth
- Switchable Pedestal with Gain Compensation
- Pre-Programmed Horizontal and Vertical Timing
- 13.5 Mpps Pixel Rate
- Master or slave (CCIR656) operation
- MPEG Interface
- Internal Interpolation Filters Simplify Output Reconstruction Filters
- 9-Bit D/A Converters for Video Reconstruction
- Supports NTSC and PAL Standards

- Output Encoding Per Macrovision Copy Protection (Revision 6) Available (TMC2491)
- Closed-Caption Waveform Insertion
- Simultaneous S-Video (Y/C) Output
- Controlled Edge Rates
- JTAG (IEEE Std 1149.1-1990) Test Interface
- Single +5V Power Supply
- 44 Lead PLCC Package
- Parallel and Serial Control Interface

Applications

- Settop Digital Cable Television Receivers
- Settop Digital Satellite Television Receivers
- Studio Parallel CCIR-601 to Analog Conversion

Description

The TMC2490 video encoder converts digital component video (in 8-bit parallel CCIR-601/656 or ANSI/SMPTE 125M format) into a standard analog baseband television (NTSC, NTSC-EIA, all PAL standards) signal with a modulated color subcarrier. Both composite (single lead) and S-Video (separate chroma and luma) formats are active simultaneously at all three analog outputs. Each video output generates a standard video signal capable of driving a singly- or doubly-terminated 75 Ohm load.

The TMC2490 is fabricated in a submicron CMOS process and is packaged in a 44-lead PLCC. Performance is guaranteed over the full 0°C to 70°C operating temperature range.

Preliminary Information

Block Diagram

24473A

Rev. 0.9.3
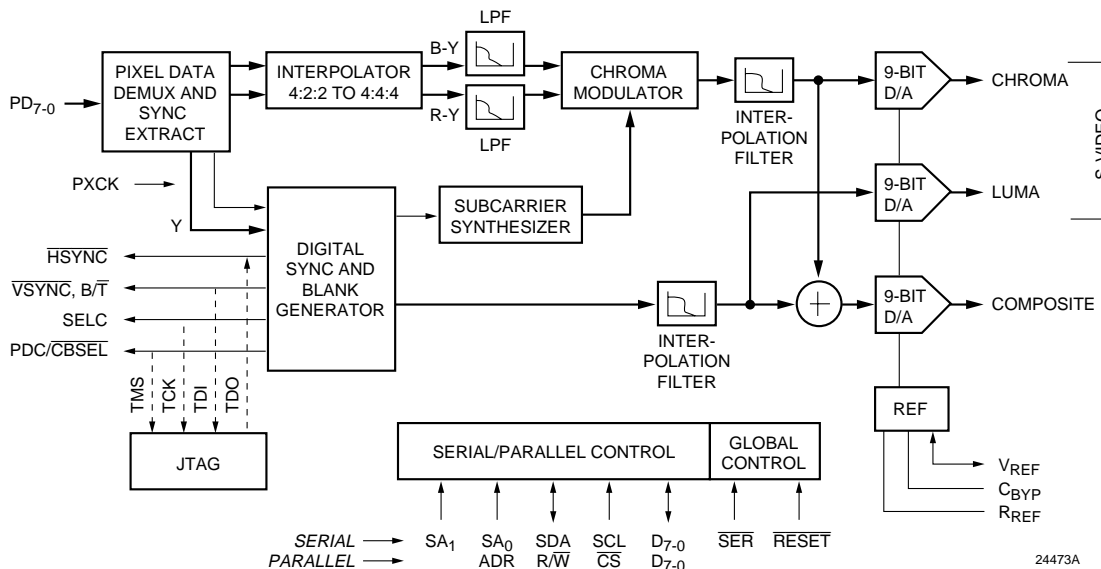
Functional Description

The TMC2490 is a fully-integrated digital video encoder with simultaneous composite and Y/C (S-Video) outputs, compatible with NTSC, NTSC-EIA, and all PAL television standards. No external component selection or tuning is required.

To prevent unauthorized video taping, the output data stream may be modified per the Macrovision copy protection system (Revision 6). This feature is available on the TMC2491 only to Macrovision licensees. Consult the factory for information.

Digital component video is accepted at the PD port in 8-bit parallel CCIR-601/656 format. It is demultiplexed into luminance and chrominance components. The chrominance components modulate a digitally synthesized subcarrier. The luminance and chrominance signals are then separately interpolated to twice the input pixel rate and converted to analog signals by 9-bit D/A converters. They are also digitally combined and the resulting composite signal is output by a third 9-bit D/A converter.

The TMC2490 operates from a single clock at 27 MHz, twice the system pixel rate. Programmable control registers allow software control of subcarrier frequency and phase parameters. Incoming YC_BC_R422 digital video is interpolated to YC_BC_R444 format for encoding.

Internal control registers can be accessed over a standard 8-bit parallel microprocessor port or a 2-pin (clock and data) serial port.

Sync Generator

The TMC2490 operates in master or slave mode. In slave mode, it extracts its horizontal and vertical sync timing and field information from the CCIR-656 SAV (Start of Active Video) and EAV (End of Active Video) signal in the incoming data stream. In master mode, it generates a 13.5MHz timebase and sends line and field synchronizing signals to the host system.

Horizontal and vertical synchronization pulses in the analog output are digitally generated by the TMC2490 with controlled rise and fall times on all sync edges, the beginning and end of active video, and the burst envelope.
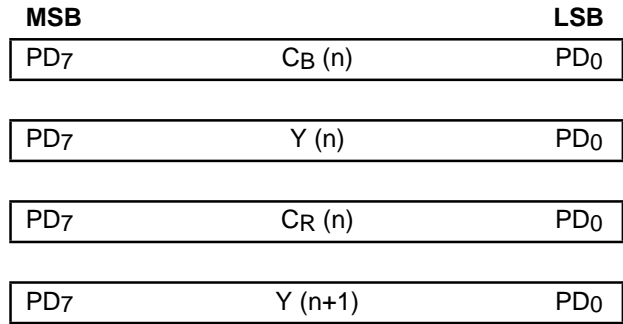
MSB		LSB
PD_7	$C_B(n)$	PD_0

PD_7	$Y(n)$	PD_0

PD_7	$C_R(n)$	PD_0

PD_7	$Y(n+1)$	PD_0

Figure 1. Pixel Data Format

Chroma Modulator

A digital subcarrier synthesizer generates the reference for a quadrature modulator, producing a digital chrominance signal. The chroma bandwidth may be programmed to 650kHz or 1.3 MHz.

Interpolation Filters

Interpolation filters on the luminance and chrominance signals double the pixel rate before D/A conversion. This low-pass filtering and oversampling process reduces sin(x)/x roll-off, and greatly simplifies the analog reconstruction filter required after the D/A converters.

D/A Converters

Analog outputs of the TMC2490 are driven by three 9-bit D/A converters, operating at 27 MHz. The outputs drive standard video levels into 37.5 or 75 Ohm loads. An internal voltage reference is used to provide reference current for the D/A converters. For more accurate video levels, an external fixed or variable voltage reference source is accommodated. The video signal levels from the TMC2490 may be adjusted to overcome the insertion loss of analog low-pass output filters by varying R_{REF} or V_{REF}.

Parallel and Serial Microprocessor Interfaces

The parallel microprocessor interface employs 11 pins. These are shared with the serial interface. A single pin, $\overline{SER}$, selects between the two interface modes.

In parallel interface mode, one address pin is decoded for access to the internal control register and its pointer. Controls are reached by loading a desired address through the 8-bit D_{7-0} port, followed by the desired data (read or write)

for that address. The control register address pointer auto-increments to address 22h and then remains there.

A 2-line serial interface is also provided on the TMC2490 for initialization and control. The same set of registers accessed by the parallel port is available to the serial port.
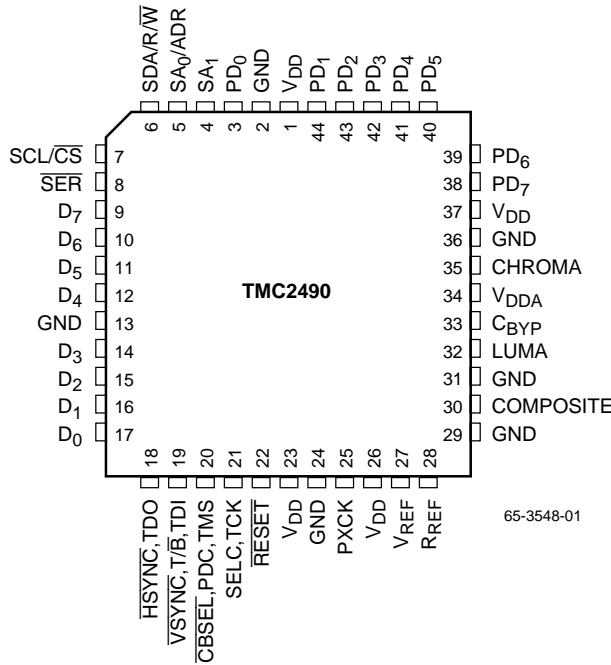
The $\overline{\text{RESET}}$ pin sets all internal state machines and control registers to their initialized conditions, disables the analog outputs, and places the encoder in a reset mode. At power-up, the encoder is automatically initialized in NTSC-M format.

JTAG Test Interface

The TMC2490 includes a standard 4-line JTAG (IEEE Std 1149.1-1990) test interface port, providing access to all digital input/output data pins. This is provided to facilitate board-level testing of the TMC2490.

Pin Assignments

65-3548-01

Preliminary Information

Pin Descriptions

Pin Name	Pin Number	Value	Pin Function Description
Clock			
PXCK	25	TTL	**Pixel Clock Input.** This 27.0 MHz clock is internally divided by 2 to generate the internal pixel clock. PXCK drives the entire TMC2490, except the asynchronous microprocessor interface. All internal registers are strobed on the rising edge of PXCK.
Data Input Port			
PD_{7-0}	38–44, 3	TTL	**Pixel Data Inputs.** Video data enter the TMC2490 on PD_{7-0} (Figure 1).
Microprocessor Interface			
D_{7-0}	9–12, 14–17	TTL	**Data I/O, General Purpose I/O, Chroma Input Port.** When $\overline{SER}$ is HIGH, all control parameters are loaded into and read back over this 8-bit port. When $\overline{SER}$ = LOW, D_0 can serve as a composite sync output, D_1 outputs a burst flag during the back porch, D_{2-5} are General Purpose Outputs, and D_{6-7} are General Purpose Inputs.
$\overline{RESET}$	22	TTL	**Master Reset Input.** Bringing $\overline{RESET}$ LOW forces the internal state machines to their starting states and disables all outputs.
SA_1	4	TTL	**Serial/Parallel Port Select.** When $\overline{SER}$ is LOW, SA_1 in conjunction with SA_0 selects one of four addresses for the TMC2490.
SA_0, ADR	5	TTL	**Serial/Parallel Port Select.** When $\overline{SER}$ is LOW, SA_0 in conjunction with SA_1 selects one-of-four addresses for the TMC2490. When $\overline{SER}$ is HIGH, this control governs whether the parallel microprocessor interface selects a table address or reads/writes table contents.
SDA, $R/\overline{W}$	6	R-Bus/TTL	**Serial Data/Read/Write Control.** When $\overline{SER}$ is LOW, SDA is the data line of the serial interface. When $\overline{SER}$ is HIGH, the pin is the read/write control for the parallel interface. When $R/\overline{W}$ and $\overline{CS}$ are LOW, the microprocessor can write to the control registers over D_{7-0}. When $R/\overline{W}$ is HIGH and $\overline{CS}$ is LOW, it can read the contents of any selected control register over D_{7-0}.
SCL, $\overline{CS}$	7	R-Bus/TTL	**Serial Clock/Chip Select.** When $\overline{SER}$ is LOW, SCL is the clock line of the serial interface. When $\overline{SER}$ is HIGH, the pin is the chip select control for the parallel interface. When $\overline{CS}$ is HIGH, the microprocessor interface port, D_{7-0}, is set to HIGH impedance and ignored. When $\overline{CS}$ is LOW, the microprocessor can read or write parameters over D_{7-0}.
$\overline{SER}$	8	TTL	**Serial/Parallel Port Select.** When LOW, the 2-line serial interface is activated. Pins 5, 6, and 7 function as SA_0, SDA, and SCL respectively. When HIGH, the parallel interface port is active and pins 5, 6, and 7 function as ADR, $R/\overline{W}$, and $\overline{CS}$ respectively.
Outputs			
CHROMA	35	1.35V p-p	**Chrominance-only Video.** Analog output of chrominance D/A converter, maximum output is 1.35 volts peak-to-peak into a doubly terminated 75 Ohm load.
COMPOSITE	30	1.35V p-p	**Composite NTSC/PAL Video.** Analog output of composite D/A converter, maximum output is 1.35 volts peak-to-peak into a doubly terminated 75 Ohm load.

Pin Descriptions (continued)

Pin Name	Pin Number	Value	Pin Function Description
LUMA	32	1.35V p-p	**Luminance-only Video.** Analog output of luminance D/A converter, maximum output is 1.35 volts peak-to-peak into a doubly terminated 75 Ohm load.
Analog Interface			
C_{BYP}	33	0.1µF	**Reference Bypass Capacitor.** Connection point for 0.1 µF decoupling capacitor to V_{DD} at pin 34..
R_{REF}	28	787Ω	**Current-setting Resistor.** Connection point for external current-setting resistor for D/A converters. The resistor is connected between R_{REF} and GND. Output video levels are inversely proportional to the value of R_{REF}.
V_{REF}	27	+1.235V	**Voltage Reference Input.** External voltage reference input, internal voltage reference output, nominally 1.235 V.
SYNC Out and JTAG Test Interface			
$\overline{HSYNC}$, TDO	18	TTL	**Horizontal Sync Out/JTAG Data Output Port.** Dual-function pin.
$\overline{VSYNC}$, T/$\overline{B}$, TDI	19	TTL	**Vertical Sync I/O, Odd/Even Field ID Output, and JTAG Data Input.** Triple-function pin.
$\overline{CBSEL}$, PDC, TMS	20	TTL	**Pixel Data Phase Output, Video Blanking Output, and JTAG Scan Select Port.** Triple-function pin.
SELC, TCK	21	TTL	**Luma/Chroma MUX Control and JTAG Scan Clock Input.** Dual-function pin.
Power Supply			
V_{DD}	1, 23, 26, 37	+5V	**Power Supply.** Positive power supply.
GND	2, 13, 24, 29, 31, 36	0.0V	**Ground.** Ground.
V_{DDA}	34	+5V	**Analog Power Supply.** Positive power supply.

Preliminary Information

Control Registers

The TMC2490 is initialized and controlled by a set of registers which determine the operating modes.

An external controller is employed to write and read the Control Registers through either the 8-bit parallel or 2-line serial interface port. The parallel port, D_{7-0}, is governed by pins $\overline{CS}$, R/$\overline{W}$, and ADR. The serial port is controlled by SDA and SCL.

Preliminary Information

Table 1. Control Register Map

Reg	Bit	Mnemonic	Function
TMC2490 Identification Registers (Read only)			
00	7-0	PARTID2	Reads back 94h
01	7-0	PARTID1	Reads back 24h
02	7-0	PARTID0	Reads back 90h
03	7-0	REVID	Silicon revision #
Global Control Register			
04	7	MASTER	Master Mode
04	6	Reserved	Program LOW
04	5	YCDELAY	Luma to chroma delay
04	4	RAMPEN	Modulated ramp enable
04	3	YCDIS	LUMA, CHROMA disable
04	2	COMPDIS	COMPOSITE disable
04	1-0	FORMAT	Television standard select
Video Output Control Register			
05	7	PALN	Select PAL-N Subcarrier
05	6	$\overline{BURSTF}$	Burst flag disable
05	5	CHRBW	Chroma bandwidth select
05	4	SYNCDIS	Sync pulse disable
05	3	BURDIS	Color burst disable
05	2	LUMDIS	Luminance disable
05	1	CHRDIS	Chrominance disable
05	0	PEDEN	Pedestal enable
Field ID Register			
06	7-6	Reserved	Program LOW
06	5-3	FIELD	Field ID (Read only)
06	2-0	Reserved	Program LOW
Reserved Registers			
07-0D	7-0	Reserved	Program LOW

Reg	Bit	Mnemonic	Function
General Purpose Port Register			
0E	7	PORT7-6	General purpose Inputs
0E	6	PORT5-2	General purpose Outputs
0E	1	BURSTF	Burst Flag Output
0E	0	CSYNC	Composite Sync Output
General Control Register			
0F	7	PED21	VBI Pedestal Enable
0F	6	$\overline{JTAGEN}$	JTAG Enable
0F	5	VSEL	Vertical Sync Select
0F	4	CBSEL	CBSEL/PDC Pin Function
0F	3	VBIEN	VBI Pixel Data Enable
0F	2-0	Reserved	Program LOW
Reserved Registers			
10-1F	7-0	Reserved	May be left unprogrammed
Closed-Caption Insertion Registers			
20	7-0	CCD1	First Byte of CC Data
21	7-0	CCD2	Second Byte of CC Data
22	7	CCON	Enable CC Data Packet
22	6	CCRTS	Request To Send Data
22	5	CCPAR	Auto Parity Generation
22	4	CCFLD	CC Field Select
22	3-0	CCLINE	CC Line Select

Notes:

1. For each register listed above, all bits not specified are reserved and should be set to zero to ensure proper operation.

Table 2. Default Register Values on Reset

Reg	Dflt	Reg	Dflt	Reg	Dflt	Reg	Dflt	Reg	Dflt
00	94	04	00	08	00	0C	00	20	80
01	24	05	00	09	00	0D	00	21	80
02	90	06	00	0A	00	0E	00	22	00
03	xx	07	00	0B	00	0F	00		

Control Register Definitions

Reg	Bit	Name	Description
00	7–0	PARTID2	Reads back 94h
01	7–0	PARTID1	Reads back 24h
02	7–0	PARTID0	Reads back 90h
03	7–0	REVID	Reads back a value corresponding to the revision letter of the silicon.

Global Control Register (04)

7	6	5	4	3	2	1	0
MASTER	Reserved	YCDELAY	RAMPEN	YCDIS	COMPDIS	FORMAT	

Reg	Bit	Name	Description
04	7	MASTER	**Master Mode.** When MASTER = 1, the encoder generates its own video timing and outputs signals $\overline{VSYNC}$ (or T/$\overline{B}$), $\overline{HSYNC}$, SELC, and PDC (or CBSEL). When MASTER = 0, the TMC2490 extracts timing from the embedded EAV codeword in the video datastream and optionally outputs signals $\overline{VSYNC}$ (or T/$\overline{B}$), $\overline{HSYNC}$, SELC, and PDC (or CBSEL).
04	6	Reserved	Program LOW
04	5	YCDELAY	**Luma to chroma delay.** When HIGH, the luminance path within the TMC2490 is delayed by one PXCK period. The delay applies to both COMPOSITE and LUMA outputs and may be used to compensate for group delay variation of external filters. When LOW, luminance and chrominance have the same latency.
04	4	RAMPEN	**Modulated ramp enable.** When HIGH, the TMC2490 outputs a modulated ramp test signal. When LOW, incoming digital video is encoded.
04	3	YCDIS	**LUMA, CHROMA disable.** When HIGH, the LUMA and CHROMA outputs are disabled, reducing power consumption. Set LOW for normal enabled operation.
04	2	COMPDIS	**COMPOSITE disable.** When HIGH, the COMPOSITE output is disabled. Set LOW for normal enabled operation.
04	1–0	FORMAT	**Television standard select.** Selects basic H&V timing parameters and subcarrier frequency. Pedestal level and chrominance bandwidth are independently programmed. 0 0 NTSC 0 1 PAL-B,G,H,I,N 1 0 PAL-M 1 1 Reserved

Preliminary Information

Control Register Definitions (continued)

Video Output Control Register (05)

7	6	5	4	3	2	1	0
PALN	$\overline{\text{BURSTF}}$	CHRBW	SYNCDIS	BURDIS	LUMDIS	CHRDIS	PEDEN

Reg	Bit	Name	Description
05	7	PALN	**Select PAL-N Subcarrier.** When HIGH, selects PAL-N subcarrier frequency. When LOW, the encoder produces the PAL-B,G,H,I subcarrier. Program LOW for NTSC and PAL-M video.
05	6	$\overline{\text{BURSTF}}$	**Burst flag disable.** When $\overline{\text{BURSTF}}$ is LOW, a clamp gate signal is produced on the D1 output and register 0E bit 1.
05	5	CHRBW	**Chroma bandwidth select.** When LOW, the chrominance bandwidth is ±650 kHz. When HIGH, the chrominance bandwidth is ±1.3 MHz.
05	4	SYNCDIS	**Sync pulse disable.** When HIGH, horizontal and vertical sync pulses on the COMPOSITE video output are suppressed (to blanking level). Color burst, active video, and the $\overline{\text{CSYNC}}$ output remain active. Set LOW for normal composite video operation.
05	3	BURDIS	**Color burst disable.** When HIGH, color burst is suppressed (blanking level). Set LOW for normal operation.
05	2	LUMDIS	**Luminance disable.** When HIGH, incoming Y values are forced to black level. Color burst, CHROMA, and sync are not affected. Set LOW for normal operation.
05	1	CHRDIS	**Chrominance disable.** When HIGH, incoming color components C_B and C_R are suppressed, enabling monochrome operation. Output color burst is not affected. Set LOW for normal color operation.
05	0	PEDEN	**Pedestal enable.** When LOW, black and blanking are the same level for ALL lines. When HIGH, a 7.5 IRE pedestal is inserted into the output video for NTSC and PAL-M lines 23-262 and 286-525 only. Chrominance and luminance gain factors are adjusted to keep video levels within range. PEDEN is valid for NTSC and PAL-M only and should be LOW for all other formats.

Field Data Register (06)

7	6	5	4	3	2	1	0
Reserved			FIELD		Reserved		

Reg	Bit	Name	Description
06	7–6	Reserved	Program LOW.
06	5–3	FIELD	**Field ID (Read only).** A value of 000 corresponds to field 1 and 111 corresponds to field 8.
06	2–0	Reserved	Program LOW.

Preliminary Information

Control Register Definitions (continued)

Reserved Registers (07–0D)

7	6	5	4	3	2	1	0
			Reserved				

Reg	Bit	Name	Description
07–0D	7–0	Reserved	Program LOW.

General Purpose Port Register (0E)

7	6	5	4	3	2	1	0
PORT7	PORT6	PORT5	PORT4	PORT3	PORT2	BURSTF	CSYNC

Reg	Bit	Name	Description
0E	7–6	PORT7–6	**General purpose Inputs.** When in serial control mode, these register read-only bits indicate the state present on data port pins D_7 and D_6.
0E	5–2	PORT5–2	**General purpose Outputs.** When in serial control mode or when reading register 0E in parallel control mode, these register read/write bits drive data pins D_5–D_2 to the state contained in the respective register bits.
0E	1	BURSTF	**Burst Flag Output.** Produces Burst Flag on data pin D_1 when in serial control mode, or when reading register 0E.
0E	0	CSYNC	**Composite Sync Output.** Produces Composite Sync on data pin D_0 when in serial control mode, or when reading register 0E.

Preliminary Information

Control Register Definitions (continued)

General Control Register (0F)

7	6	5	4	3	2	1	0
PED21	JTAGEN	VSEL	CBSEL	VBIEN	Reserved		

Reg	Bit	Name	Description
0F	7	PED21	**VBI Pedestal Enable.** When HIGH and FORMAT is 00 (NTSC) or 10 (PAL-M), pedestal is added to lines 21, 22, 283, 284, 285. When LOW, no pedestal is placed on these lines. PED21 is valid for NTSC and PAL-M only and should be LOW for all other formats.
0F	6	JTAGEN	**JTAG Enable.** When LOW, the JTAG port is active. When HIGH, the JTAG port is disabled, and signals $\overline{VSYNC}$ (or T/$\overline{B}$), $\overline{HSYNC}$, SELC, and PDC (or CBSEL) appear on the JTAG pins.
0F	5	VSEL	**Vertical Sync Select.** When LOW, the TMC2490 outputs a traditional vertical sync on $\overline{VSYNC}$. When HIGH, the chip outputs odd/even field identification on the $\overline{VSYNC}$ pin, with 0 denoting an odd field.
0F	4	CBSEL	**CBSEL/PDC pin function.** When CBSEL = 0, the PDC signal is produced on the CBSEL/PCD pin. When CBSEL = 1, the CBSEL signal is produced on the CBSEL/PDC pin.
0F	3	VBIEN	**VBI Pixel Data Enable.** When VBIEN = 0, the vertical interval lines are blanked. When VBIEN = 1, Pixel data is encoded into the VBI lines. VBI blanking is available only in master mode.
0F	2–0	Reserved	Program LOW.

Reserved Registers (10–1F)

7	6	5	4	3	2	1	0
Reserved							

Reg	Bit	Name	Description
10–1F	7–0	Reserved	May be left unprogrammed

Preliminary Information

Control Register Definitions (continued)

Closed-Caption Insertion (20)

7	6	5	4	3	2	1	0
CCD1							

Reg	Bit	Name	Description
20	7–0	CCD1	**First Byte of CC Data.** Bit 0 is the LSB. The MSB will be overwritten by an ODD Parity bit if CCPAR is HIGH.

Closed-Caption Insertion (21)

7	6	5	4	3	2	1	0
CCD2							

Reg	Bit	Name	Description
21	7–0	CCD2	**Second Byte of CC Data.** Bit 0 is the LSB. The MSB will be overwritten by an ODD Parity bit if CCPAR is HIGH.

Closed-Caption Insertion (22)

7	6	5	4	3	2	1	0
CCON	CCRTS	CCPAR	CCFLD	CCLINE			

Reg	Bit	Name	Description
22	7	CCON	**Enable CC Data Packet.** Command the CC data generator to send either CC data or a NULL byte whenever the specified line is transmitted.
22	6	CCRTS	**Request To Send Data.** This bit is set HIGH by the user when bytes 20 and 21 have been loaded with the next two bytes to be sent. When the encoder reaches the falling edge of the HSYNC preceding the line specified in bits 4-0 of this register, data will be transferred from registers 20 and 21, and RTS will be reset LOW. A new pair of bytes may then be loaded into registers 20 and 21. If CCON = 1 and CCRTS = 0 when the CC line is to be sent, NULL bytes will be sent.
22	5	CCPAR	**Auto Parity Generation.** When set HIGH, the encoder replaces the MSB of bytes 20 and 21 with a calculated ODD parity. When set LOW, the CC processor transmits the 16 bits exactly as loaded into registers 20 and 21.
22	4	CCFLD	**CC Field Select.** When LOW, CC data is transmitted on the selected line of ODD fields. When HIGH, it is sent on EVEN fields.
22	3–0	CCLINE	**CC Line Select.** Defines (with an offset) the line on which CC data are transmitted.

Preliminary Information

General Purpose Port

The TMC2490 provides a general purpose I/O port for system utility functions. Input, output, and sync functions are implemented. Register 0E is the General Purpose Register.

Full functionality is provided when the encoder is in Serial control mode ($\overline{SER}$ = LOW). Most of the functions are available in parallel interface mode ($\overline{SER}$ = HIGH).

General Purpose Input (serial mode only)

Bits 7 and 6 of Register 0E are general purpose inputs. When the encoder is in serial control mode, data bits D_7 and D_6 are mirrored to these register locations. When Register 0E is read, the states of bits 7 and 6 reflect the TTL logic levels present on D_7 and D_6, respectively, at the time of read command execution. Writing to these bits has no effect.

This function is not available when the encoder is in parallel control mode.

General Purpose Output

Register 0E read/write bits 5-2 are connected to pins D_{5-2}, respectively, when the encoder is in serial control mode. The output pins continually reflects the values most recently written into register 0E (1 = HIGH, 0 = LOW). Note that these pins are always driven outputs when the encoder is in serial control mode.

When register 0E is read, these pins report the values previously stored in the corresponding register bits, i.e., it acts as a read/write register. When the encoder is in parallel control mode, this reading produces the output bit values on the corresponding data pins, just as in the serial control mode. However, the values are only present when reading register 0E. The controller can command a continuous read on this register to produce continuous outputs from these pins.

Burst Flag and Composite Sync (output/read-only)

Register 0E bit 1 is associated with the encoder burst flag. It is a 1 (HIGH) from just before the start of the color burst to just after the end of the burst. It is a 0 (LOW) at all other times.

Register 0E bit 0 outputs the encoder composite sync status. It is a 0 (LOW) during horizontal and vertical sync tips. It is a 1 (HIGH) at all other times.

These register bits may be read at any time over either the serial or parallel control port. As they are dynamic, their states will change as appropriate during a parallel port read. In fact, if the parallel control port is commanded to read register 0E continually, the pins associated with these bits behave as burst flag and composite sync timing outputs.

In serial control mode, these same data output pins (D_{1-0}) always act as a burst flag and composite sync TTL outputs, the conditions of the serial control notwithstanding. The states of the flags may be read over the serial port, but due to the low frequency of the serial interface, it may be difficult to get meaningful information.

Pixel Interface

The TMC2490 interfaces with an 8-bit 13.5 Mpps (27 MHz) video datastream. It will automatically synchronize with embedded Timing Reference Signals, per CCIR-656. It also includes a master sync generator on-chip, which may produce outputs.

CCIR-656 Mode

When operating in CCIR-656 Mode (MASTER = 0), the TMC2490 identifies the SAV and EAV 4-byte codewords embedded in the video datastream and, from them, derives all timing. Both SAV and EAV are required.

When $\overline{JTAGEN}$ = 0, the JTAG port is operational. When $\overline{JTAGEN}$ = 1, SYNC signals are output and JTAG is not available.

MASTER Mode

When in MASTER Mode (MASTER = 1), and JTAGEN = 1, the Encoder produces its own timing, and provides $\overline{HSYNC}$, $\overline{VSYNC}$ (or B/$\overline{T}$), SELC, and PDC (or $\overline{CBSEL}$) to the Pixel Data Source.

JTAG is not available.

SELC Output

The SELC output toggles at 13.5 Msps (1/2 the pixel rate), providing a phase reference for the multiplexed luma/chroma CCIR-656 format datastream. It is HIGH during the rising edge of the clock intended to load chroma data. This is useful when interfacing with a 16-bit data source, and can drive a Y/C multiplexer.

CBSEL Output

The CBSEL output identifies the CB element of the C_B-Y-C_R-Y CCIR-656 data sequence. It is HIGH during the rising edge of the clock intended to load C_B data. This can prevent unintentionally swapping the C_B and C_R color components when operating in MASTER mode and reading data from a framestore.

PDC Output

The PDC output is a blanking signal, indicating when the Encoder expected to receive pixel data. It goes HIGH four clocks before the first pixel is required, and goes LOW four clocks before the last pixel is accepted to accommodate pipeline delays in the video data source.
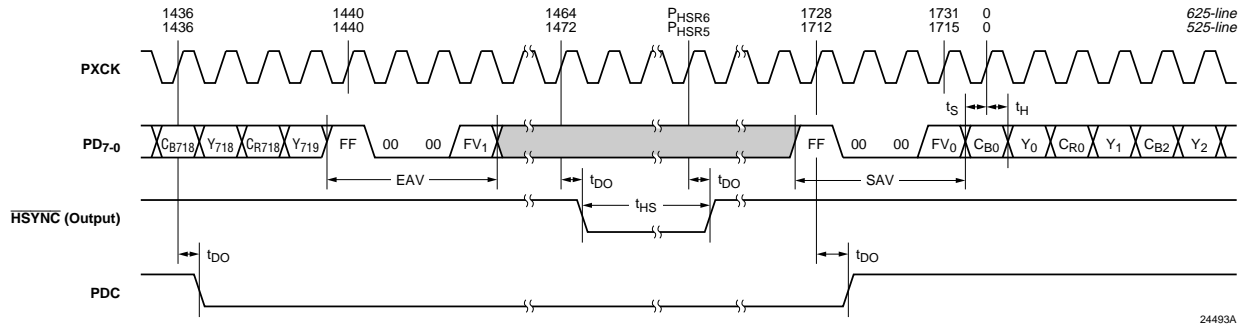
Figure 2. CCIR-656 Horizontal Interval Timing Detail
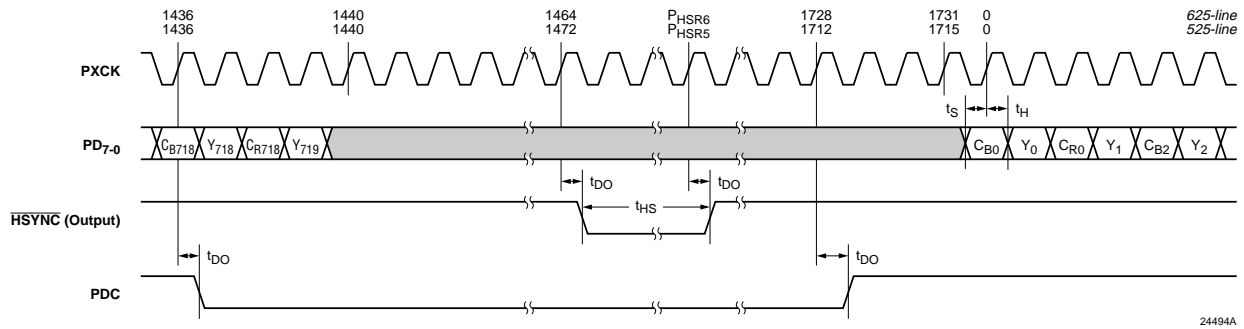

Figure 3. Master Mode Horizontal Interval Timing Detail

Horizontal and Vertical Timing

Horizontal and vertical video timing in the TMC2490 is pre-programmed for line-locked systems with a 2x pixel clock of 27.0 MHz.

Table 3 and Table 4 show timing parameters for NTSC and PAL standards and the resulting TMC2490 analog output timing. The user provides exactly 720 pixels of active video per line. In master mode, the TMC2490 precisely controls the duration and activity of every segment of the horizontal line and vertical field group. In external sync slave mode, it holds the end-of-line blank state (e.g. front porch for active video lines) until it receives the next horizontal sync signal. In CCIR-656 slave mode, it likewise holds each end-of-line blank state until it receives the next end of active video (EAV) signal embedded in the incoming data stream. (See timing diagrams.)

The vertical field group comprises several different line types based upon the Horizontal line time.

$$H = (2 \times SL) + (2 \times SH) \text{ [Vertical sync pulses]}$$
$$= (2 \times EL) + (2 \times EH) \text{ [Equalization pulses]}$$

SMPTE 170M NTSC and Report 624 PAL video standards call for specific rise and fall times on critical portions of the video waveform. The chip does this automatically, requiring no user intervention. The TMC2490 digitally defines slopes compatible with SMPTE 170M NTSC or CCIR Report 624 PAL on all vital edges:

1. Sync leading and trailing edges.

2. Burst envelope.

3. Active video leading and trailing edges.

4. All vertical interval equalization pulse and sync edges.

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Table 3. Horizontal Timing Standards and Actual Values for 60 fps Video Standards (μs)

Parameter		NTSC (SMPTE 170M)			PAL-M (CCIR 624)			TMC2490
		Min	Nom	Max	Min	Nom	Max	
Front porch	FP	1.4	1.5	1.6	1.27		2.22	1.53
Horiz. Sync	SY	4.6	4.7	4.8	4.6	4.7	4.8	4.74
Breezeway	BR	0.508	0.608	0.809	0.9	1.1	1.3	0.59 (NTSC) 1.04 (PAL-M)
Color Burst	BU	2.235	2.514	2.794	2.237	2.517	2.797	2.31
Color Back porch	CBP	0.998	1.378	1.857	0.503		2.363	1.65 (NTSC) 0.89 (PAL-M)
Blanking	BL	10.5	10.7	11.0	10.7	10.9	11.1	10.8
Active Video	VA	52.56	52.86	53.06	52.46	52.66	52.86	52.633
Line Time	H		63.556			63.556		63.557
Equalization HIGH	EH		29.5			29.5		29.47
Equalization LOW	EL		2.3			2.3		2.31
Sync HIGH	SH		4.7			4.7		4.67
Sync LOW	SL		27.1			27.1		27.13
Sync rise and fall times			140±20ns			<250 ns		135ns

Table 4. Horizontal Timing Standards and Actual Values for 50 fps Video Standards (μs)

| Parameter		PAL-B,G,H,I (CCIR 624)			PAL-N (CCIR 624)			TMC2490
		Min	Nom	Max	Min	Nom	Max	
Front porch	FP	1.2	1.5	1.8	1.2	1.5	1.8	1.57
Horiz. Sync	SY	4.5	4.7	4.9	4.5	4.7	4.9	4.74
Breezeway	BR	0.6	0.9	1.2	0.6	0.9	1.2	0.89
Color Burst	BU	2.030	2.255	2.481	2.233	2.513	2.792	2.3
Color Back porch	CBP		2.654			2.387		2.3
Blanking	BL	11.7	12.0	12.3	11.7	12.0	12.3	1.8
Active Video	VA	51.7	52.0	52.3	51.7	52.0	52.3	52.2
Line Time	H		64			64		64.0
Equalization HIGH	EH		29.65			29.65		29.63
Equalization LOW	EL		2.35			2.35		2.37
Sync HIGH	SH		4.7			4.7		4.67
Sync LOW	SL		27.3			27.3		27.3
Sync rise and fall times			250±50 ns			200±100 ns		250

Preliminary Information
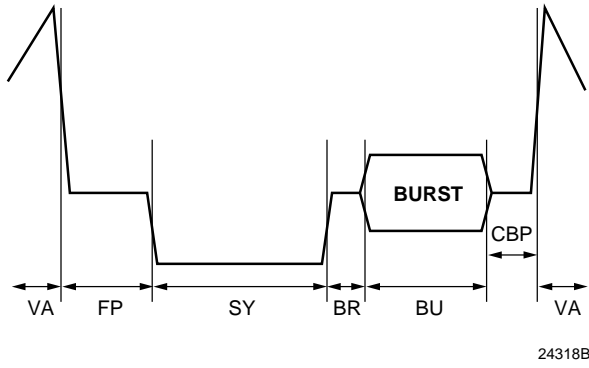
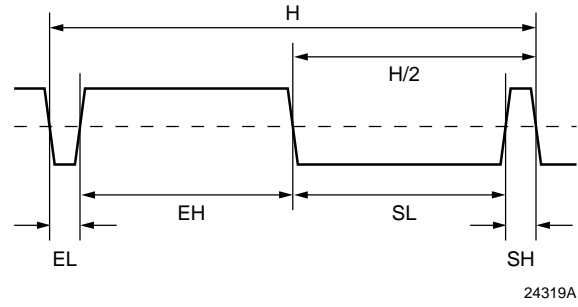**Figure 4. Horizontal Blanking Interval Timing**
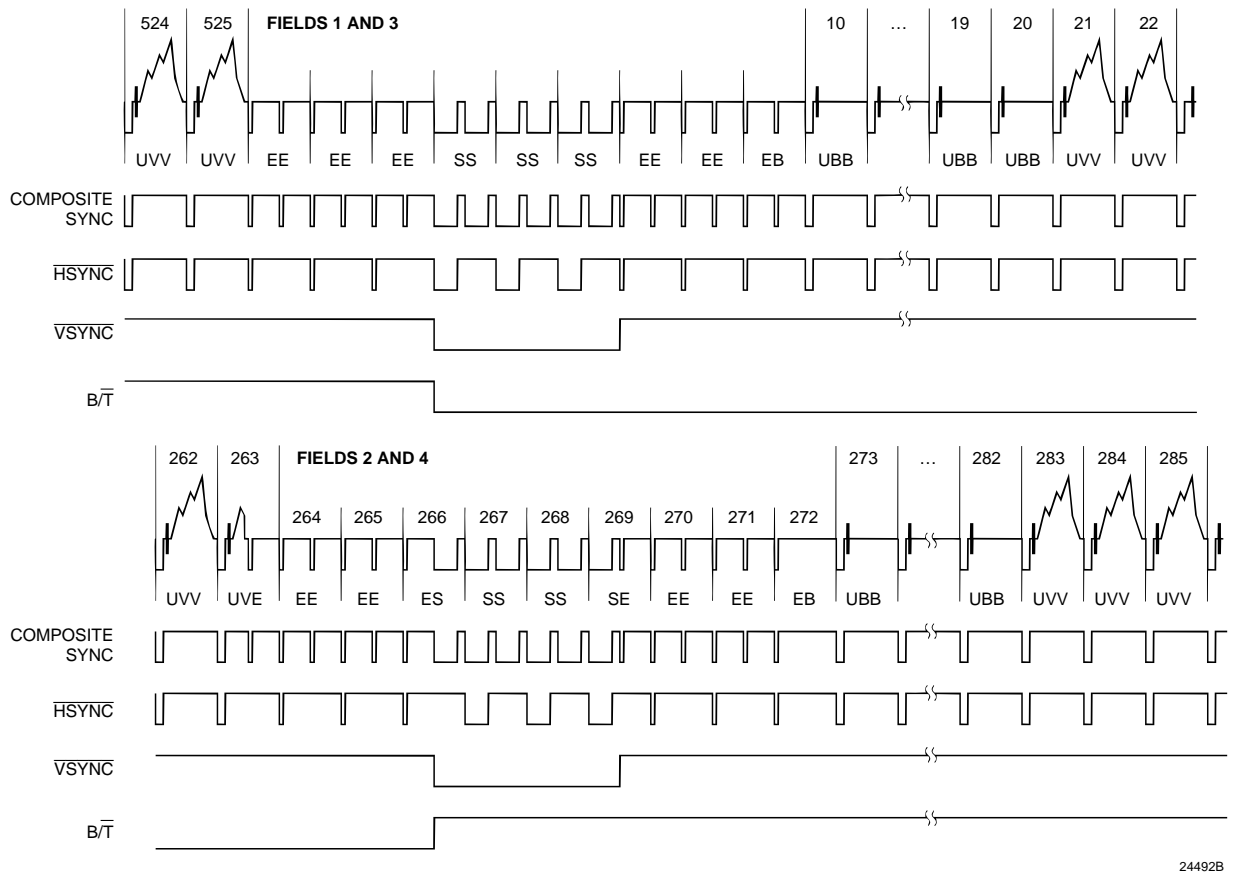
Figure 5. Vertical Sync and Equalization Pulse Detail

Figure 6. NTSC Vertical Interval

Preliminary Information
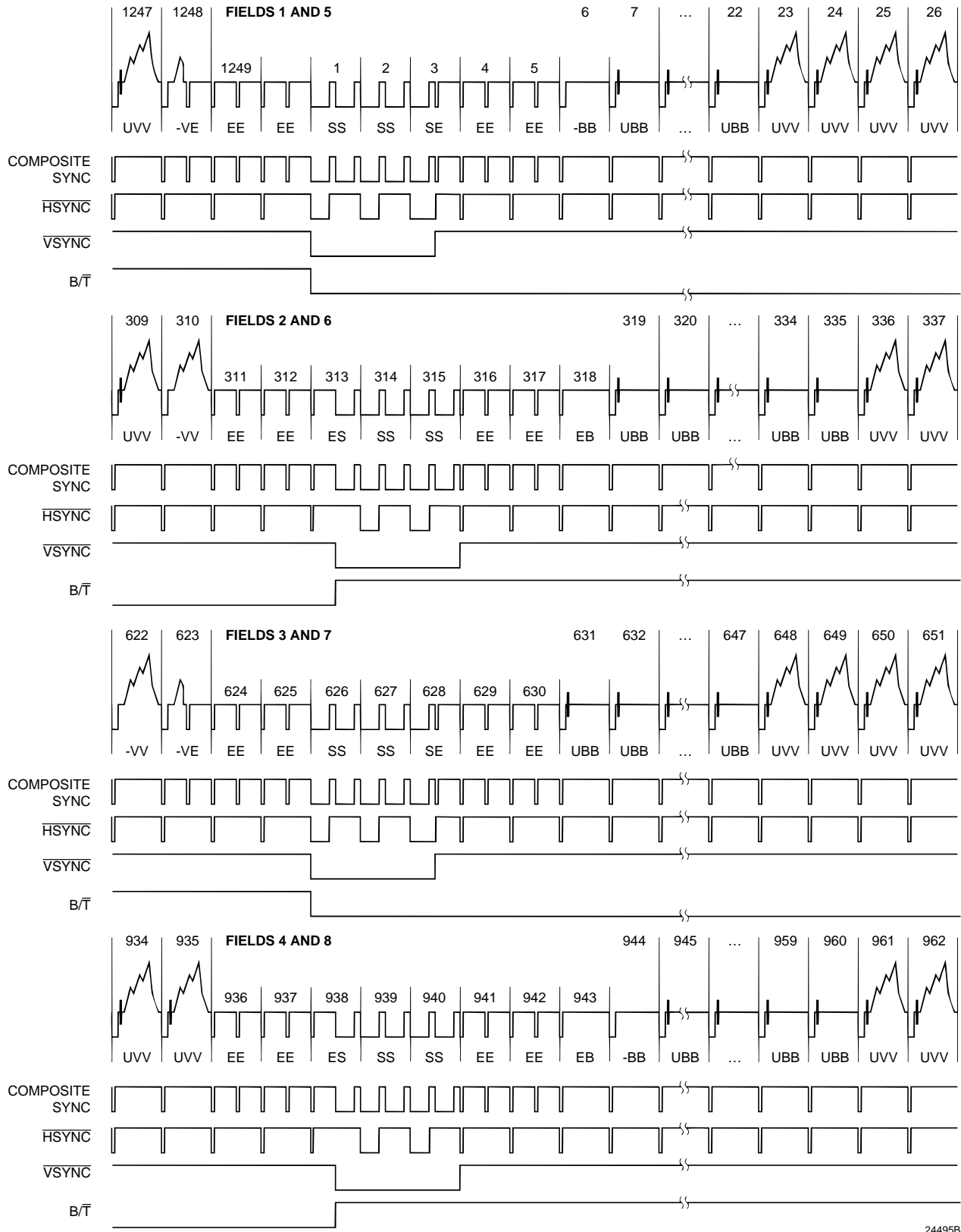
Table 6. NTSC Field/Line Sequence and Identification

Field 1, FID = 00		Field 2, FID = 01		Field 3, FID = 10		Field 4, FID = 11	
Line	ID	Line	ID	Line	ID	Line	ID
1	EE	264	EE	1	EE	264	EE
2	EE	265	EE	2	EE	265	EE
3	EE	266	ES	3	EE	266	ES
4	SS	267	SS	4	SS	267	SS
5	SS	268	SS	5	SS	268	SS
6	SS	269	SE	6	SS	269	SE
7	EE	270	EE	7	EE	270	EE
8	EE	271	EE	8	EE	271	EE
9	EE	272	EB	9	EE	272	EB
10	UBB	273	UBB	10	UBB	273	UBB
…	…	…	…	…	…	…	…
20	UBB	282	UBB	20	UBB	282	UBB
21	UVV	283	UVV	10	UVV	273	UVV
…	…	…	…	…	…	…	…
262	UVV	524	UVV	262	UVV	524	UVV
263	UVE	525	UVV	263	UVE	525	UVV

EE	Equalization pulse	EB	Equalization broad pulse
SE	Half-line vertical sync pulse, half-line equalization pulse	UBB	Black and Burst[1]
SS	Vertical sync pulse	UVV	Active video
ES	Half-line equalization pulse, half-line vertical sync pulse	UVE	Half-line video, half-line equalization pulse

Note:

1. VBB lines are changed to UVV (Active Video) when VBIEN = 1.

Figure 7. PAL-B,G,H,I,N Vertical Interval

Preliminary Information

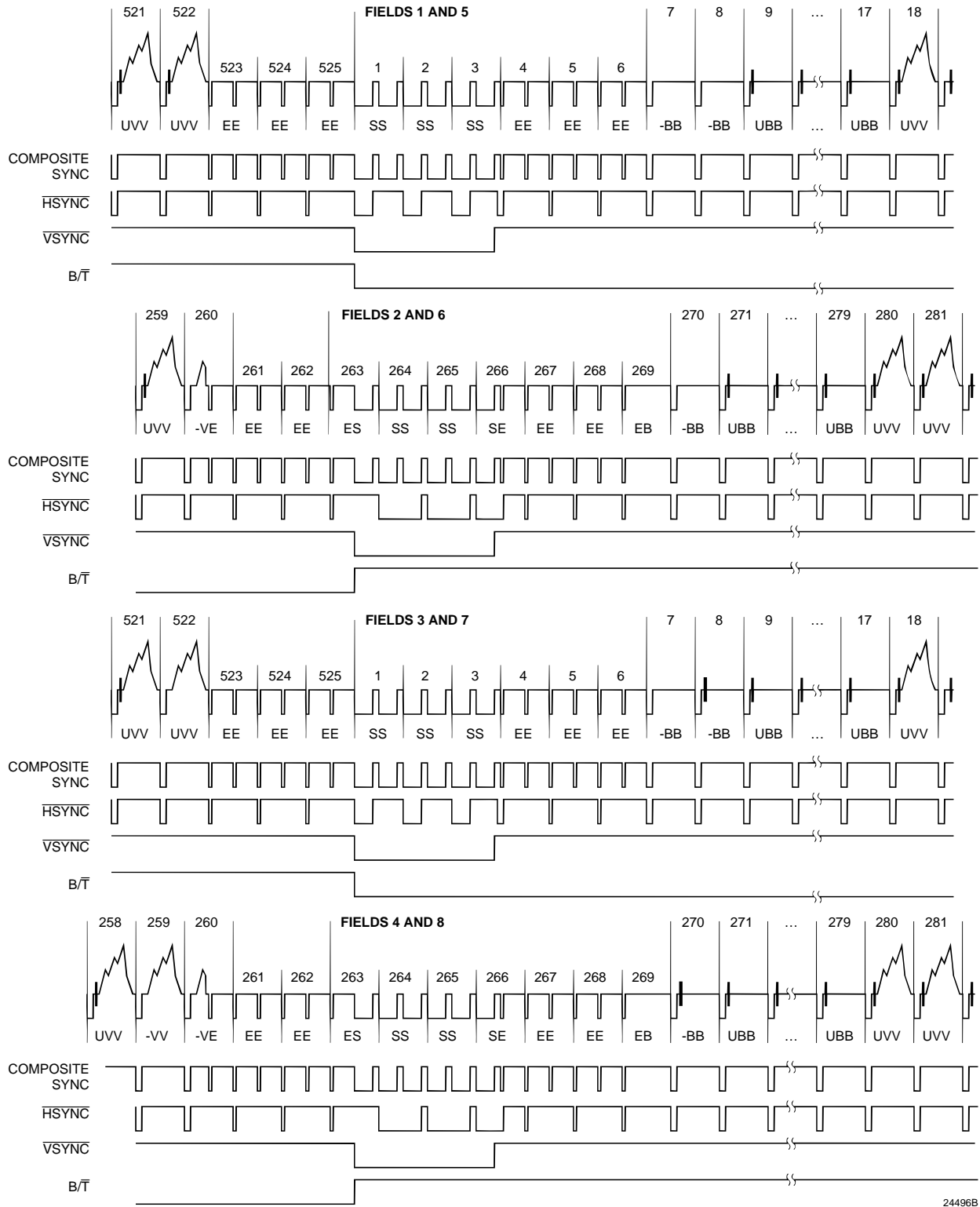**Table 7. PAL-B,G,H,I,N Field/Line Sequence and Identification**

Fields 1 and 5 FID = 000, 100		Fields 2 and 6 FID = 001, 101		Fields 3 and 7 FID = 010, 110		Fields 4 and 8 FID = 011, 111	
Line	ID	Line	ID	Line	ID	Line	ID
1	SS	313	ES	626	SS	938	ES
2	SS	314	SS	627	SS	939	SS
3	SE	315	SS	628	SE	940	SS
4	EE	316	EE	629	EE	941	EE
5	EE	317	EE	630	EE	942	EE
6	-BB	318	EV	631	UBB	943	EB
7	UBB	319	UBB	632	UBB	944	-BB
8	UBB	320	UBB	633	UBB	945	UBB
…	…	…	…	…	…	…	…
22	UBB	335	UBB	647	UBB	960	UBB
23	UVV	336	UVV	648	UVV	961	UVV
…	…	…	…	…	…	…	…
308	UVV	621	UVV	933	UVV	1246	UVV
309	UVV	622	-VV	934	UVV	1247	UVV
310	-VV	623	-VE	935	UVV	1248	-VE
311	EE	624	EE	936	EE	1249	EE
312	EE	625	EE	937	EE	1250	EE

EE   Equalization pulse

SE   Half-line vertical sync pulse, half-line equalization pulse

SS   Vertical sync pulse

ES   Half-line equalization pulse, half-line vertical sync pulse

EB   Equalization broad pulse

UBB   Black and Burst[1]

UVV   Active video

-BB   Blank line with color burst suppression[2]

-VV   Active video with color burst suppressed

-VE   Half-line video, half-line equalization pulse, color burst suppressed

Notes:

1. VBB lines are changed to UVV (Active Video) when VBIEN = 1.
2. -BB lines are changed to -VV (Active Video, Burst Suppressed) when VBIEN = 1.

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Figure 8. PAL-M Vertical Interval

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Table 8. PAL-M Field/Line Sequence and Identification

Field 1 and 5 FID = 000, 100		Field 2 and 6 FID = 001, 101		Field 3 and 7 FID = 010, 110		Field 4 and 8 FID = 011, 111	
Line	ID	Line	ID	Line	ID	Line	ID
1	SS	263	ES	1	SS	263	ES
2	SS	264	SS	2	SS	264	SS
3	SS	265	SS	3	SS	265	SS
4	EE	266	SE	4	EE	266	SE
5	EE	267	EE	5	EE	267	EE
6	EE	268	EE	6	EE	268	EE
7	-BB	269	EB	7	-BB	269	EB
8	-BB	270	-BB	8	UBB	270	-BB
9	UBB	271	UBB	9	UBB	271	UBB
…	…	…	…	…	…	…	…
17	UBB	279	UBB	17	UBB	279	UBB
18	UVV	280	UVV	18	UVV	280	UVV
…	…	…	…	…	…	…	…
258	UVV	521	UVV	258	UVV	521	UVV
259	UVV	522	-VV	259	-VV	522	UVV
260	-VE	523	EE	260	-VE	523	EE
261	EE	524	EE	261	EE	524	EE
262	EE	525	EE	262	EE	525	EE

EE	Equalization pulse	UBB	Black and Burst[1]
SE	Half-line vertical sync pulse, half-line equalization pulse	UVV	Active video
SS	Vertical sync pulse	-BB	Blank line with color burst suppression[2]
ES	Half-line equalization pulse, half-line vertical sync pulse	-VV	Active video with color burst suppressed
EB	Equalization broad pulse	UVV	half-line black, half-line video
-VE	Half-line video, half-line equalization pulse, color burst suppressed		

Notes:

1. VBB lines are changed to UVV (Active Video) when VBIEN = 1
2. -BB lines are changed to -VV (Active Video, Burst Suppressed) when VBIEN = 1

Subcarrier Generation and Synchronization

The color subcarrier is produced by an internal digital frequency synthesizer. The subcarrier synthesizer gets its frequency and phase values preprogrammed into the TMC2490.

In Master Mode, the subcarrier is internally synchronized on field 1 of the eight-field sequence to establish and maintain a specific relationship between the leading edge of horizontal sync and color burst phase (SCH). Proper subcarrier phase is maintained through the entire eight field set, including the 25 Hz offset in PAL-N/B/I systems. The subcarrier is reset to the phase values found in Table 9.

SCH Phase Control

SCH refers to the timing relationship between the 50% point of the leading edge of horizontal sync and the first positive or negative zero-crossing of the color burst subcarrier reference. In PAL, SCH is defined for line 1 of field 1, but since there is no color burst on line 1, SCH is usually measured at line 7 of field 1. The need to specify SCH relative to a particular line in PAL is due to the 25 Hz offset of PAL subcarrier frequency. Since NTSC has no such 25 Hz offset, SCH applies to all lines.

Table 9. Subcarrier and Color Burst Reset Values

	NTSC	PAL-M	PAL-B,G,H,I,N
Digital field:	1	1	1
Line number:	4	4	1
Subcarrier phase reset value:	180°	0°	0°
Resultant color burst phase:	0°	+135°	+135°

Note:

1. Line numbering is in accordance with Figure 6, Figure 7, and Figure 8. Subcarrier and color burst phase are relative to the horizontal reference of the line specified above.

Table 10. Standard Subcarrier Parameters

Standard	Horizontal Frequency (KHz)	Subcarrier Frequency (MHz)
NTSC	15.734266	3.579545455
PAL B,G,H,I	15.625000	4.43361875
PAL-M	15.734266	3.57561189
PAL-N	15.625000	3.58205625

Luminance Processing

During horizontal and vertical blanking, the luma processor generates blanking levels and properly timed and shaped sync and equalization pulses. During active video, it captures and rescales the incoming Y components and adds the results to the blank level to complete a proper monochrome television waveform, which is then upsampled to drive the luma D/A and the composite adder.

For NTSC-EIA (5:2 white:sync, no black pedestal), the overall luma input-to-output equation for $0<Y<255$ is:

luma out (IRE, relative to blank) = (Y - 16) * 100/219

For NTSC and PAL-M (5:2, with 7.5 IRE pedestal), the equation becomes:

luma out (IRE, relative to blank) = (Y - 16) * 92.5/219 + 7.5

For all 625-line PAL standards (7:3, no pedestal), the equation becomes:

luma out (mV, relative to blank) = (Y-16) * 700/219

Since Y=0 and Y=255 are reserved values in CCIR-601, results in the luma D/A outputting black, i.e., 0mV or 0 IRE without pedestal, 7.5 IRE with pedestal.

Table 11. Luminance Input Codes

PD7-0 Input		Luma Level (CCIR-601)	NTSC, PAL-M Luma Level (IRE)		PAL-B,G,H,I,N Luma Level (mV)
Dec	Hex		PEDEN = 0	PEDEN = 1	
255	FF	Reserved	0	7.5	0
254	FE		108.7	108	761
235	EB	100% white	100	100	700
16	10	Black	0	7.5	0
1	01		-6.9	1.2	-48
0	00	Reserved	0	7.5	0

Table 12. D/A Converter and Analog Levels

Video Level	NTSC, PAL-M		NTSC w/o Setup		PAL-B,G,H,I,N	
	D/A	IRE	D/A	IRE	D/A	mV
Maximum Output	511	134.8	511	138.4	511	964
100% white	410	100	410	100	400	700
Black	142	7.5	120	0	128	0
Blank	120	0	120	0	128	0
Sync	4	-40	4	-40	6	-300
White-to-blank	290	100	290	100	280	700
White-to- sync	406	140	406	140	406	1000
Color burst p-p	116	40	116	40	122	300

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Filtering Within the TMC2490

The TMC2490 incorporates internal digital filters to establish appropriate bandwidths and simplify external analog reconstruction filter designs.

The chroma portion of the incoming digital video is band-limited to reduce edge effect and other distortions of the image compression process. Chrominance bandwidth is selected by CHRBW. When LOW, the chrominance passband attenuation is <3 dB within ±650 kHz from f_{SC}. The stopband rejection is >26 dB outside f_{SC} ±2 MHz. When HIGH, the chrominance passband attenuation is <3 dB within ±1.3 MHz from f_{SC}. The stopband rejection is >33 dB outside f_{SC} ±4 MHz.
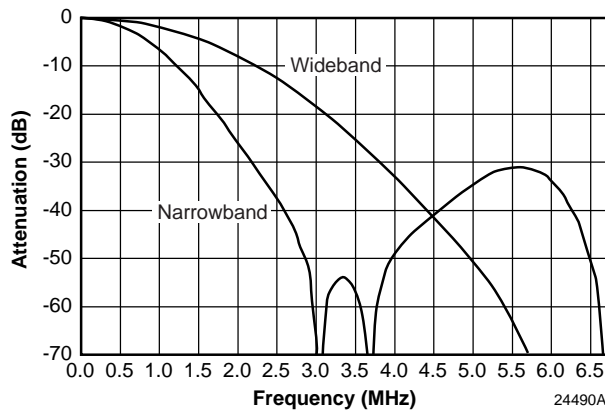
Figure 9. Color-Difference Low-Pass Filter Response

The Chroma Modulator output and the luminance data are digitally filtered with sharp-cutoff low-pass interpolation filters. These filters ensure that aliased subcarrier, chrominance, and luminance frequencies are sufficiently suppressed above the video base-band and below the pixel frequency range ($f_S/4$ to $3 \times f_S/4$, where f_S is the PXCK frequency).
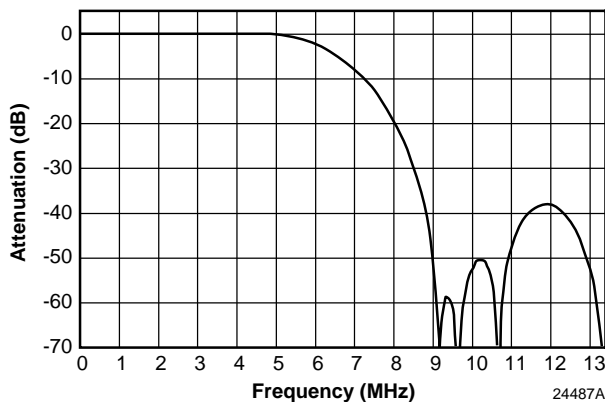
Figure 10. Chrominance and Luminance Interpolation Filter - Full Spectrum Response

Virtually all digital-to-analog converters have a response

with high frequency roll-off as a result of the zero-order hold characteristic of classic D/A converters. This response is commonly referred to as a sin(x)/x response. The sin(x)/x vs. sampling frequency is shown in Figure 12.
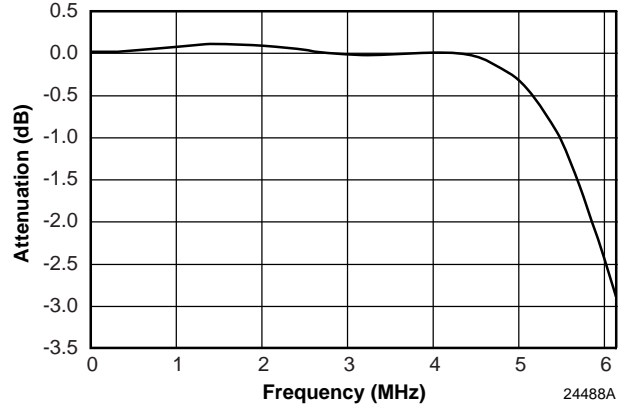

Figure 11. Chrominance and Luminance Interpolation Filter - Passband Detail

The TMC2490's digital interpolation filters convert the data stream to a sample rate of twice the pixel rate. This results in much less high frequency sin(x)/x rolloff and the output spectrum between $f_S/4$ and $3 \times f_S/4$ contains very little energy. Since there is so little signal energy in this frequency band, the demands placed on the output reconstruction filter are greatly reduced. The output filter needs to be flat to $f_S/4$ and have good rejection at $3 \times f_S/4$. The relaxed requirements greatly simplify the design of a filter with good phase response and low group delay distortion. A small amount of peaking may be added to compensate residual sin(x)/x rolloff.
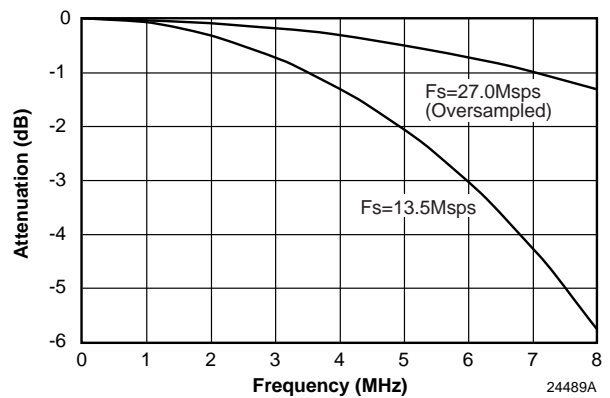

Figure 12. Sin(x)/x Response

Closed Caption Insertion

The TMC2490 includes a flexible closed caption processor. It may be programmed to insert a closed caption signal on any line within a range of 16 lines on ODD and/or EVEN fields.

Closed Caption insertion overrides all other configurations of the encoder: if it is specified on an active video line, it takes precedence over the video data and removes NTSC setup if setup has been programmed for the active video lines.

Closed Caption Control

Closed caption is turned on by setting CCON HIGH. Whenever the encoder begins producing a line specified by CCFLD and CCLINE, it will insert a closed caption line in its place. If CCRTS is HIGH, the data contained in CCDx will be sent. IF CCRTS is LOW, Null Bytes (hex 00 with ODD parity) will be sent.

Line Selection

The line to contain CC data is selected by a combination of the CCFLD bit and the CCLINE bits. CCLINE is added to the offset shown in Table 13 to specify the line.

Table 13. Closed Caption Line Selection

Standard	Offset	Field	Lines
525	12	ODD	12-27
	274	EVEN	274-289
625	9	ODD	9-24
	321	EVEN	321-336

Parity Generation

Standard Closed-Caption signals employ ODD parity, which may be automatically generated by setting CCPAR HIGH. Alternatively, parity may be generated externally as part of the bytes to be transmitted, and, with CCPAR LOW, the entire 16 bits loaded into the CCDx registers will be sent unchanged.

Operating Sequence

A typical operational sequence for closed-caption insertion on Line 21 is:

1. Read Register 22 and check that bit 6 is LOW, indicating that the CCDx registers are ready to accept data.

2. If ready, write two bytes of CC data into registers 20 and 21.

3. Write into register 22 the proper combination of CCFLD and CCLINE. CCPAR may be written as desired. Set CCRTS HIGH.

4. The CC data is transmitted during the specified line.

As soon as CCDx s transferred into the CC processor (and CCRTS goes LOW), new data may be loaded into registers 20 and 21. This allows the user to transmit CC data on several consecutive lines by loading data for line n+1 while data is being sent on line n.

Registers 20-21 autoincrement when read or written. Register 22 does not. The microcontroller can repeatedly read register 22 until CCRTS is found to be low, then address register 20 and write three autoincremented bytes to set up for the next CC line.

Parallel Microprocessor Interface

The parallel microprocessor interface, active when $\overline{SER}$ is HIGH, employs an 11-line interface, with an 8-bit data bus and one address bit: two addresses are required for device programming and pointer-register management. Address bit 0 selects between reading/writing the register addresses and reading/writing register data. When writing, the address is presented along with a LOW on the $R/\overline{W}$ pin during the falling edge of $\overline{CS}$. Eight bits of data are presented on D_{7-0} during the subsequent rising edge of $\overline{CS}$.

In read mode, the address is accompanied by a HIGH on the $R/\overline{W}$ pin during a falling edge of $\overline{CS}$. The data output pins go to a low-impedance state t_{DOZ} ns after $\overline{CS}$ falls. Valid data is present on D_{7-0} t_{DOM} after the falling edge of $\overline{CS}$.

Table 14. Parallel Port Control

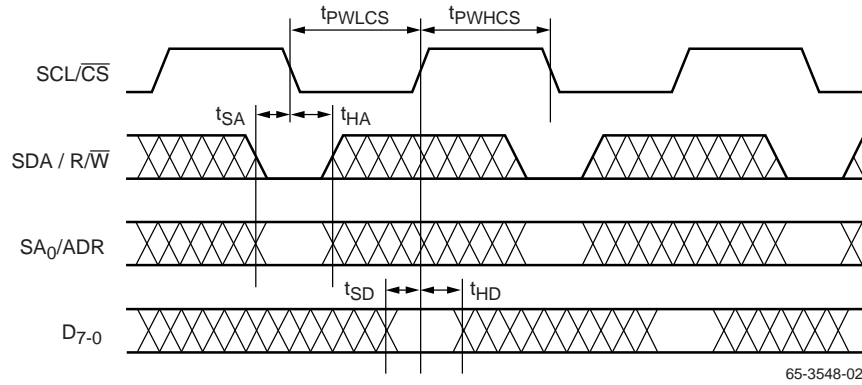| ADR	R/$\overline{W}$	Action
1	0	Load D_{7-0} into Control Register pointer.
1	1	Read Control Register pointer on D_{7-0}.
0	0	Write D_{7-0} to addressed Control Register.
0	1	Read addressed Control Register on D_{7-0}.

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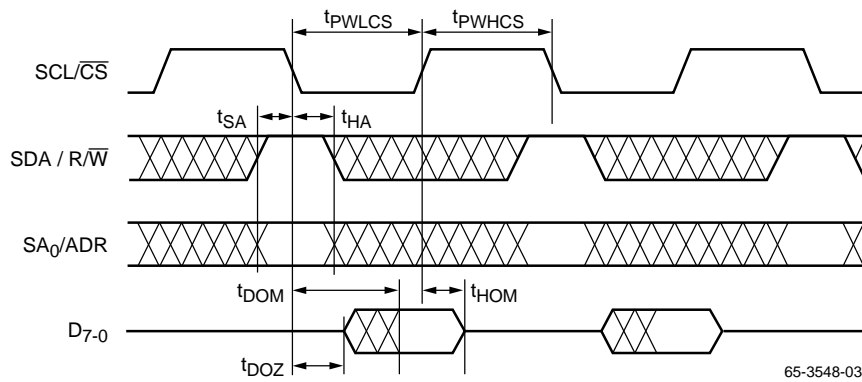**Figure 13. Microprocessor Parallel Port - Write Timing**

Figure 14. Microprocessor Parallel Port - Read Timing

Serial Control Port (R-Bus)

In addition to the 11-wire parallel port, a 2-wire serial control interface is also provided, and active when $\overline{SER}$ is LOW. Either port alone can control the entire chip. Up to four TMC2490 devices may be connected to the 2-wire serial interface with each device having a unique address.

The 2-wire interface comprises a clock (SCL/$\overline{CS}$) and a bi-directional data (SDA/R/$\overline{W}$) pin. The TMC2490 acts as a slave for receiving and transmitting data over the serial interface. When the serial interface is not active, the logic levels on SCL/$\overline{CS}$ and SDA/R/$\overline{W}$ are pulled HIGH by external pull-up resistors.

Data received or transmitted on the SDA/R/W\ line must be stable for the duration of the positive-going SCL/$\overline{CS}$ pulse. Data on SDA/R/$\overline{W}$ must change only when SCL/$\overline{CS}$ is LOW. If SDA/R/$\overline{W}$ changes state while SCL/$\overline{CS}$ is HIGH, the serial interface interprets that action as a start or stop sequence.

There are five components to serial bus operation:

• Start signal
• Slave address byte

• Base register address byte
• Data byte to read or write
• Stop signal

When the serial interface is inactive (SCL/$\overline{CS}$ and SDA/R/$\overline{W}$ are HIGH) communications are initiated by sending a start signal. The start signal is a HIGH-to-LOW transition on SDA/R/$\overline{W}$ while SCL/$\overline{CS}$ is HIGH. This signal alerts all slaved devices that a data transfer sequence is coming.

The first eight bits of data transferred after a start signal comprise a seven bit slave address and a single R/W bit. As shown in Figure 16A, the R/W bit indicates the direction of data transfer, read from or write to the slave device. If the transmitted slave address marches the address of the device (set by the state of the SA_0/ADR and SA_1 input pins in Table 15.), the TMC2490 acknowledges by bringing SDA/R/$\overline{W}$ LOW on the 9th SCL/$\overline{CS}$ pulse. If the addresses do not match, the TMC2490 does not acknowledge.

Table 15. Serial Port Addresses

A_6	A_5	A_4	A_3	A_2	A_1 (SA$_1$)	A_0 (SA$_0$)
0	0	0	1	1	0	0
0	0	0	1	1	0	1
0	0	0	1	1	1	0
0	0	0	1	1	1	1

Data Transfer via Serial Interface

For each byte of data read or written, the MSB is the first bit of the sequence.

If the TMC2490 does not acknowledge the master device during a write sequence, the SDA/R/$\overline{W}$ remains HIGH so the master can generate a stop signal. If the master device does not acknowledge the TMC2490 during a read sequence, the TMC2490 interprets this as "end of data." The SDA/R/$\overline{W}$ remains HIGH so the master can generate a stop signal.

Writing data to specific control registers of the TMC2490 requires that the 8-bit address of the control register of interest be written after the slave address has been established. This control register address is the base address for subsequent write operations. The base address autoincrements by one for each byte of data written after the data byte intended

for the base address. If more bytes are transferred than there are available addresses, the address will not increment and remain at its maximum value of 22h. Any base address higher than 22h will not produce an ACKnowledge signal.

Data is read from the control registers of the TMC2490 in a similar manner. Reading requires two data transfer operations:

The base address must be written with the R/W bit of the slave address byte LOW to set up a sequential read operation.

Reading (the R/W bit of the slave address byte HIGH) begins at the previously established base address. The address of the read register autoincrements after each byte is transferred.

To terminate a read/write sequence to the TMC2490, a stop signal must be sent. A stop signal comprises a LOW-to-HIGH transition of SDA/R/$\overline{W}$ while SCL/$\overline{CS}$ is HIGH.

A repeated start signal occurs when the master device driving the serial interface generates a start signal without first generating a stop signal to terminate the current communication. This is used to change the mode of communication (read, write) between the slave and master without releasing the serial interface lines.
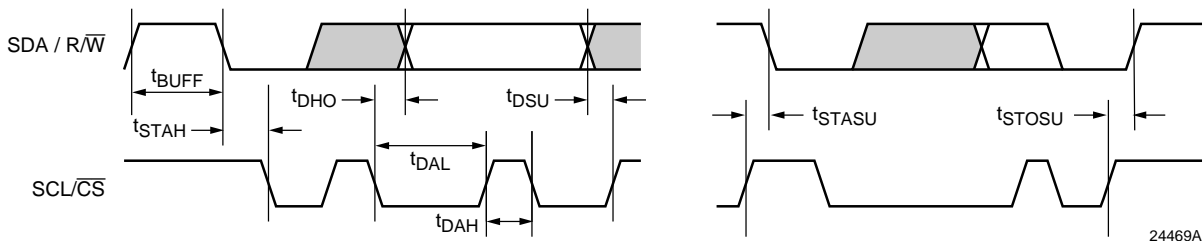
Figure 15. Serial Port Read/Write Timing

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Serial Interface Read/Write Examples

Write to one control register

- Start signal
- Slave Address byte (R/W bit = LOW)
- Base Address byte
- Data byte to base address
- Stop signal

Write to four consecutive control registers

- Start signal
- Slave Address byte (R/W bit = LOW)
- Base Address byte
- Data byte to base address
- Data byte to (base address + 1)
- Data byte to (base address + 2)
- Data byte to (base address + 3)
- Stop signal

Read from one control register

- Start signal
- Slave Address byte (R/W bit = LOW)

- Base Address byte
- Stop signal
- Start signal
- Slave Address byte (R/W bit = HIGH)
- Data byte from base address
- Stop signal

Read from four consecutive control registers

- Start signal
- Slave Address byte (R/W bit = LOW)
- Base Address byte
- Stop signal
- Start signal
- Slave Address byte (R/W bit = HIGH)
- Data byte from base address
- Data byte from (base address + 1)
- Data byte from (base address + 2)
- Data byte from (base address + 3)
- Stop signal

Preliminary Information
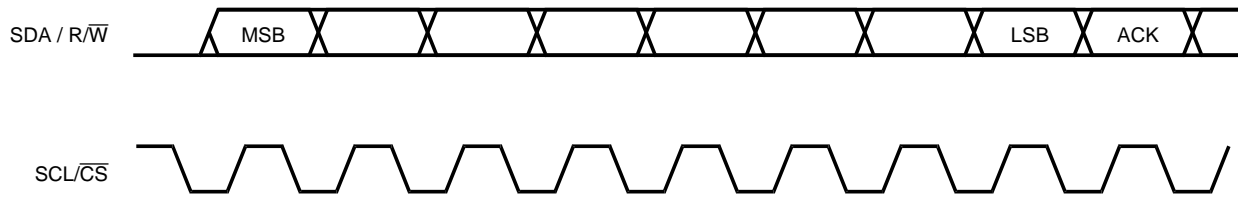
24470A

Figure 16. Serial Interface – Typical Byte Transfer
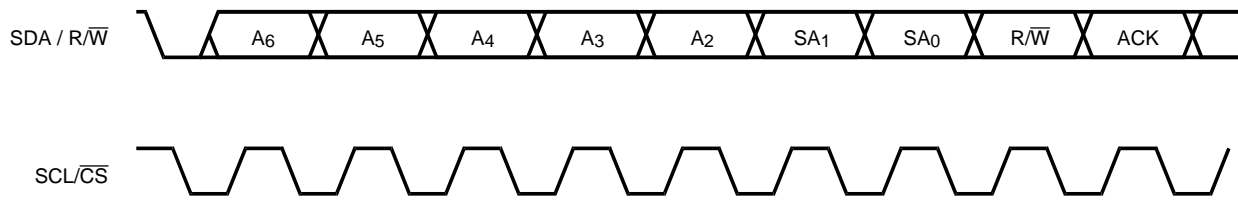
65-3648-05

Figure 16A. Chip Address with Read/Write Bit

JTAG Test Interface

The JTAG test port accesses registers at every digital I/O pin except the JTAG test port pins.

Table 16 specifies the sequence of the test registers. The register number (Reg) indicates the order in which the register data is loaded and read (Reg 1 is loaded and read first, therefore it is at the end of the serial path). The scan path is 23 registers long.

The JTAG port is a 4-wire interface, following IEEE Std. 1149.1-1990 specifications. The Test Data Input (TDI) and Test Mode Select (TMS) inputs are referred to the rising edge of the Test ClocK (TCK) input. The Test Data Output (TDO) is referred to the falling edge of TCK.

The JTAG standard has been implemented into the TMC2490 without the UPDATE data register.

The CAPTURE Instruction Register is implemented with force value of 01 which allows SAMPLE or PRELOAD data to the data path.

The Instruction register contains two bits: IRM and IRL (TDI shift to IRM; IRM shift to IRL; IRL shift to TDO) - see Table 17.

There are 16 states in TAP and all are fully implemented.

In general, TMS is commanding the state machine and puts the system into JTAG states. The TMC2490 can be operated freely because there is no means to interrupt its function. There is NO output driver related to the JTAG data path.

While TMS determines the state, there are only a few events that may happen:

1. Capture DR. In this state, all the data at the pins will be LOADed into the data scan path only if IRM is not equal to IRL. If IRM = IRL, even though the state machine is at this state, NO ACTION will take place.

2. Shift DR. In this state, the data scan path is transferring data from high order bit to low order bits. It is always operational regardless of the contents of IRM and IRL.

3. Capture IR. While TMS captures IR state, the TMC2490 automatically loads 01 to the pre-instruction register (IRMp and IRLp respectively).

4. Shift IR. In this state, shift TDI to IRMp, IRMp to IRLp, and IRLp to TDO.

5. Update IR. In this state, TMC2490 LOAD contents of the Instruction register from the PRELOADED (or SHIFTED) IR to execution Instruction register (double buffered.)

The DATA SCAN PATH Register is a serial SHIFT, parallel LOAD shift register. While in Shift DR state, TMC2490 does SHIFT. While the IR (instruction register) is 01 or 10, and the TAP state is at Capture DR state, TMC2490 does LOAD.

For each input PIN (three-state pins included, but not the analog pins), the TMC2490 has a 2:1 multiplexer and register. One of the multiplexer inputs is the PAD and the other is the shifted data from the higher order scan path.

The JTAG test port is disabled when JTAGEN = 1.

Table 16. JTAG Sequence

Reg	Pin	Reg	Pin	Reg	Pin
1	$\overline{RESET}$	9	PD_1	17	D_6
2	PXCK	10	PD_0	18	D_5
3	PD_7	11	SA_1	19	D_4
4	PD_6	12	SA_0/ADR	20	D_3
5	PD_5	13	SDA/R$\overline{W}$	21	D_2
6	PD_4	14	SCL/$\overline{CS}$	22	D_1
7	PD_3	15	$\overline{SER}$	23	D_0
8	PD_2	16	D_7		

Table 17. Function of IRM and IRL

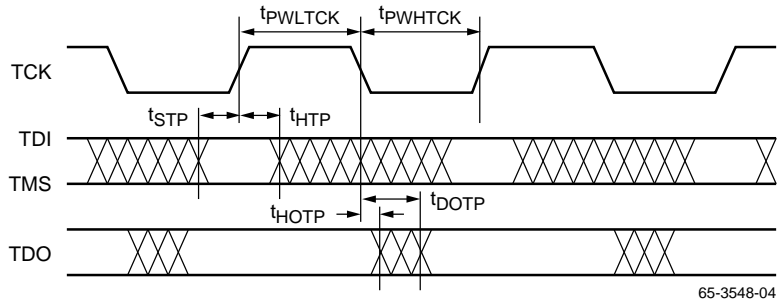| IRM	IRL	Function
0	0	EXTEST, no effect while shift at DR, data keeps on shifting.
0	1	SAMPLE/PRELOAD At capture DR state, load all input pins parallel to data scan path.
1	0	Same as SAMPLE/PRELOAD
1	1	BYPASS TDI bypass to TDO

65-3548-04

Figure 17. JTAG Test Port Timing

Equivalent Circuits

27012B
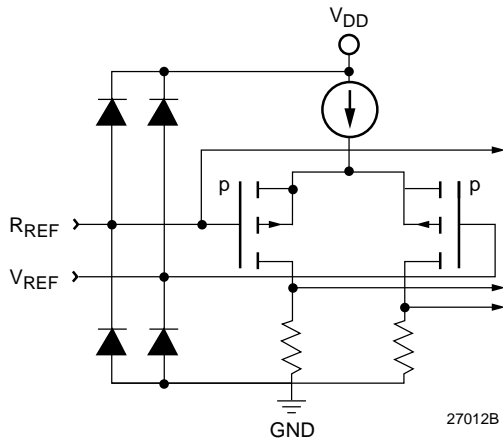
Figure 18. Equivalent Analog Input Circuit

27013B
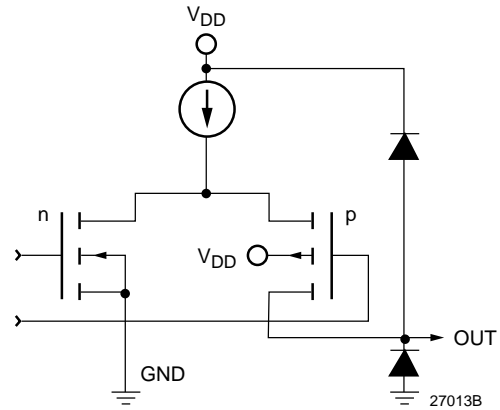
Figure 19. Equivalent Analog Output Circuit
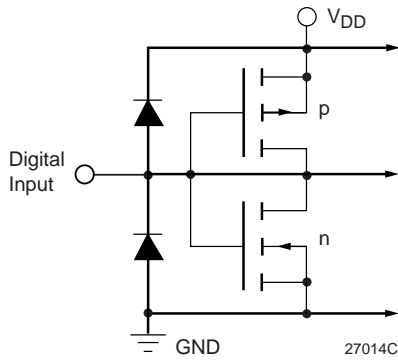

27014C

Figure 20. Equivalent Digital Input Circuit
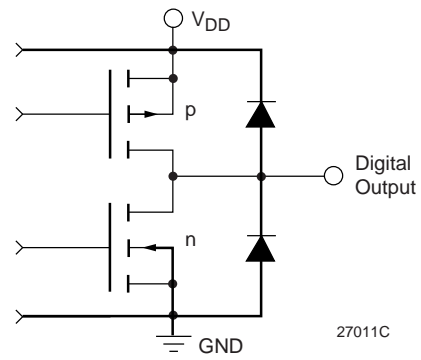

27011C

Figure 21. Equivalent Digital Output Circuit
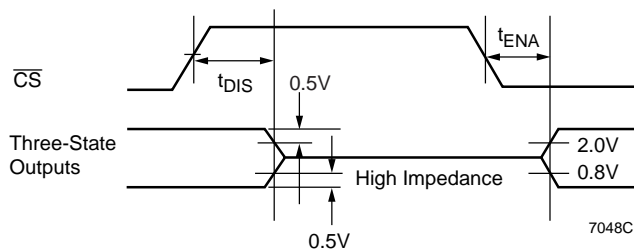

7048C

Figure 22. Threshold Levels for Three-State Measurements

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Absolute Maximum Ratings

(beyond which the device may be damaged)[1]

Parameter	Min	Typ	Max	Unit
Power Supply Voltage	-0.5		7.0	V
Digital Inputs				
Applied Voltage[2]	-0.5		V_{DD} + 0.5	V
Forced Current[3,4]	-20.0		20.0	mA
Output				
Applied Voltage[2]	-0.5		V_{DD} + 0.5	V
Forced Current[3,4]	-3.0		6.0	mA
Short Circuit Duration (single output in HIGH state to ground)			1	sec
Analog Short Circuit Duration (all outputs to ground)	Infinite			
Temperature				
Operating, Ambient	-20		110	°C
Junction			140	°C
Storage Temperature	-65		150	°C
Lead Soldering (10 seconds)			300	°C
Vapor Phase Soldering (1 minute)			220	°C

Notes:

1. Functional operation under any of these conditions is NOT implied. Performance and reliability are guaranteed only if Operating Conditions are not exceeded.
2. Applied voltage must be current limited to specified range.
3. Forcing voltage must be limited to specified range.
4. Current is specified as conventional current flowing into the device.

Operating Conditions

Parameter		Conditions	Min	Typ	Max	Units
V_{DD}	Power Supply Voltage		4.75	5.0	5.25	V
V_{IH}	Input Voltage, Logic HIGH	TTL Compatible Inputs	2.0		V_{DD}	V
		CLK Input	2.4		V_{DD}	
		R-Bus Inputs	$0.7V_{DD}$			
V_{IL}	Input Voltage, Logic LOW	TTL Compatible Inputs	GND		0.8	V
		R-Bus Inputs			$0.3V_{DD}$	
V_{REF}	External Reference Voltage			1.235		V
I_{REF}	D/A Converter Reference Current	(I_{REF} = V_{REF}/R_{REF}), flowing out of the R_{REF} pin		1.57		mA
R_{REF}	External Reference Resistor	V_{REF} = NOM		787		Ω
I_{OH}	Output Current, Logic HIGH				-2.0	mA
I_{OL}	Output Current, Logic LOW				2.0	mA
T_A	Ambient Temperature, Still Air		0		70	°C
Pixel Interface						
f_{PXL}	Pixel Rate			13.5		Mpps
f_{PXCK}	Master Clock Rate	= 2X pixel rate		27.0		MHz

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Operating Conditions (continued)

Parameter		Conditions	Min	Typ	Max	Units
tPWHPX	PXCK pulse width, HIGH		10			ns
tPWLPX	PXCK pulse width, LOW		15			ns
tSP	PD_{7-0} Setup Time		15			ns
tHP	PD_{7-0} Hold Time		0			ns
Parallel Microprocessor Interface						
tPWLCS	$\overline{CS}$ Pulse Width, LOW		95			ns
tPWHCS	$\overline{CS}$ Pulse Width, HIGH		3			pixels
tSA	Address Setup Time		17			ns
tHA	Address Hold Time		0			ns
tSD	Data Setup Time (write)		17			ns
tHD	Data Hold Time (write)		0			ns
tSR	Reset Setup Time		15			ns
tHR	Reset Hold Time		2			ns
Serial Microprocessor Interface						
tDAL	SCL Pulse Width, LOW			1.3		μs
tDAH	SCL Pulse Width, HIGH			0.6		μs
tSTAH	SDA Start Hold Time			0.6		μs
tSTASU	SCL to SDA Setup Time (Stop)			0.6		μs
tSTOSU	SCL to SDA Setup Time (Start)			0.6		μs
tBUFF	SDA Stop Hold Time Setup			1.3		μs
tDSU	SDA to SCL Data Setup Time			300		ns
tDHO	SDA to SCL Data Hold Time			300		ns
JTAG Interface						
fTCK	Test Clock (TCK) Rate				10	MHz
tPWLTCK	TCK Pulse Width, LOW		10			ns
tPWHTCK	TCK Pulse Width, HIGH		10			ns
tSTP	Test Port Setup Time, TDI, TMS		15			ns
tHTP	Test Port Hold Time, TDI, TMS		0			ns

Electrical Characteristics

Parameter		Conditions	Min	Typ	Max	Units
I_{DD}	Power Supply Current, Unloaded[2]	V_{DD} = Max, f_{PXCK} = 27MHz			120	mA
I_{DDQ}	Power Supply Current, Quiescent	V_{DD} = Max			50	mA
V_{RO}	Voltage Reference Output		1.136	1.235	1.334	V
I_{BR}	Reference Bias		-100		100	µA
Z_{RO}	V_{REF} Output Impedance			1000		Ω
I_{IH}	Input Current, HIGH	V_{DD} = Max, V_{IN} = V_{DD}			±10	µA
I_{IL}	Input Current, LOW	V_{DD} = Max, V_{IN} = 0V			±10	µA
I_{OZH}	Hi-Z Output Leakage Current, Output HIGH	V_{DD} = Max, V_{IN} = V_{DD}			±10	µA
I_{OZL}	Hi-Z Output Leakage Current, Output LOW	V_{DD} = Max, V_{IN} = 0V			±10	µA
I_{OS}	Short-Circuit Current		-50		-10	mA
V_{OH}	Output Voltage, HIGH	I_{OH} = Max	2.4			V
V_{OL}	Output Voltage, LOW	I_{OL} = Max			0.4	V
C_I	Digital Input Capacitance			4	10	pF
C_I	Digital Output Capacitance			10		pF
V_{OC}	Video Output Compliance		-0.3		2.0	V
R_{OUT}	Video Output Resistance			15		kΩ
C_{OUT}	Video Output Capacitance	I_{OUT} = 0mA, f = 1MHz		15	25	pF

Notes:
1. Maximum I_{DD} with V_{DD} = Max and T_A = Min. Outputs loaded wtih 75Ω.
2. I_{DDQ} when $\overline{RESET}$ = LOW, disabling D/A converters.

Switching Characteristics

Parameter		Conditions	Min	Typ	Max	Units
t_{DOZ}	Output Delay, $\overline{CS}$ to low-Z		4			ns
t_{HOM}	Output Hold Time, $\overline{CS}$ to high-Z		30			ns
t_{DOM}	Output Delay, $\overline{CS}$ to Data Valid				23	ns
t_{DOTP}	Output Delay, TCK to TDO Valid				13	ns
t_{HOTP}	Output Hold Time, TCK to TDO Valid		3			ns
t_R	D/A Output Current Risetime	10% to 90% of full scale		2		ns
t_F	D/A Output Current Falltime	90% to 10% of full scale		2		ns
t_{DOV}	Analog Output Delay		3	10	17	ns

Note: Timing reference points are at the 50% level. Analog C_{LOAD} <10pF, D_{7-0} load <40pF.

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System Performance Characteristics

Parameter		Conditions	Min	Typ	Max	Units
RES	D/A Converter Resolution		9	9	9	Bits
dp	Differential Phase	PXCK = 27 MHz, 40 IRE Ramp			1.0	degree
dg	Differential Gain	PXCK = 27 MHz, 40 IRE Ramp			1.5	%
CNLP	Chroma Nonlinear Phase	NTC-7 Combination			±1.25	degree
CNLG	Chroma Nonlinear Gain	NTC-7 Combination			±1.0	%
CLIM	Chroma/Luma Intermodulation	NTC-7 Combination				IRE
CLGI	Chroma/Luma Gain inequality	NTC-7 Composite			3	%
CLDI	Chroma/Luma Delay inequality	NTC-7 Composite				ns
LNLD	Luma Nonlinear Distortion	NTC-7			2	%
FTWD	Field Time Waveform Distortion	NTC-7			.5	%
LTWD	Line Time Waveform Distortion	NTC-7			.5	%
LOTWD	Long Time Waveform Distortion, initial and peak overshoot	10%/90% APL Bounce				IRE
LOTWD	Long Time Waveform Distortion, peak overshoot	after 5 seconds, 10%/90% APL Bounce				IRE
LDCOFF	Line-by-Line DC Offset					IRE
DYNG	Dynamic Gain	NTC-7				IRE
NOISE	Noise Level (Note 1)	100% unmod. ramp	-55			dB rms
CAMN	Chroma AM Noise	Red field	-63			dB rms
CPMN	Chroma PM Noise	Red field	-62			dB rms
SYR	Sync Pulse Rise Time	NTSC		137		ns
		PAL		250		
SYF	Sync Pulse Fall Time	NTSC		134		ns
		PAL		248		
PSRR	Power Supply Rejection Ratio	C_{BYP} = 0.1 μF, f = 1 kHz		0.02		%/%V_{DD}

Notes:

1. Noise Level is unified weighted, 10 kHz to 5.0 MHz bandwidth, with Tilt Null ON measured using VM700 "Measure Mode."

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Applications Information

The circuit in Figure 24 shows the connection of power supply voltages, output reconstruction filters and the external voltage reference. All VDD pins should be connected to the same power source.

The full-scale output voltage level, V_{OUT}, on the COMPOSITE, LUMA, and CHROMA pins is found from:

$$V_{OUT} = I_{OUT} \times R_L = K \times I_{REF} \times R_L$$
$$= K \times (V_{REF}/R_{REF}) \times R_L$$

where:

1. I_{OUT} is the full-scale output current sourced by the TMC2490 D/A converters.
2. R_L is the net resistive load on the COMPOSITE, CHROMA, and LUMA output pins.
3. K is a constant for the TMC2490 D/A converters (approximately equal to 10.4).
4. I_{REF} is the reference current flowing out of the R_{REF} pin to ground.
5. V_{REF} is the voltage measured on the V_{REF} pin.
6. R_{REF} is the total resistance connected between the R_{REF} pin and ground.
7. A 0.1µF capacitor should be connected between C_{BYP} and V_{DDA}.

The reference voltage in Figure 24 is from an LM185 1.2 Volt band-gap reference. The 392 Ohm resistor connected from R_{REF} to ground sets the overall "gain" of the three D/A converters of the TMC2490. Varying R_{REF} ±5% will cause the full-scale output voltage on COMPOSITE, LUMA, and CHROMA to vary by ±5%.

The suggested output reconstruction filter is the same one used on the TMC2063P7C Demonstration Board. The phase and frequency response of this filter is shown in Figure 23. The Schottky diode is for ESD protection.
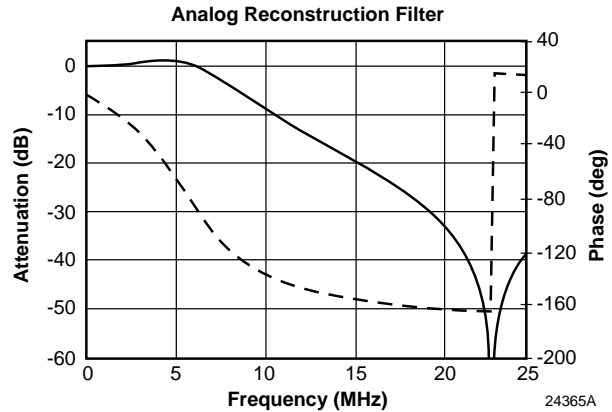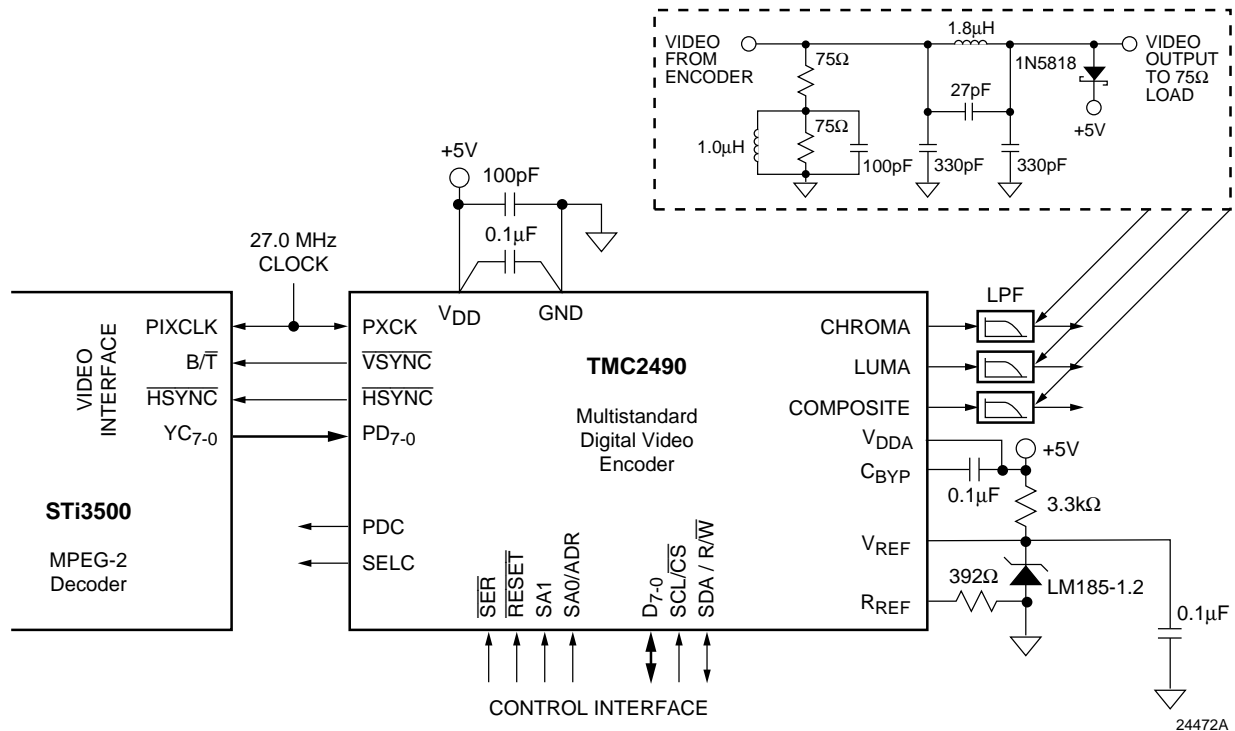

Figure 23. Response of Recommended Output Filter

**Figure 24. Typical Application Circuit**

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Preliminary Information

Notes:

Mechanical Dimensions – 44-Pin PLCC Package

Symbol	Inches		Millimeters		Notes
	Min.	Max.	Min.	Max.	
A	.165	.180	4.19	4.57	
A1	.090	.120	2.29	3.05	
A2	.020	—	.51	—	
B	.013	.021	.33	.53	
B1	.026	.032	.66	.81	
D/E	.685	.695	17.40	17.65	
D1/E1	.650	.656	16.51	16.66	3
D3/E3	.500 BSC		12.7 BSC		
e	.050 BSC		1.27 BSC		
J	.042	.056	1.07	1.42	2
ND/NE	11		11		
N	44		44		
ccc	—	.004	—	0.10	

Notes:

1. All dimensions and tolerances conform to ANSI Y14.5M-1982

2. Corner and edge chamfer (J) = 45°

3. Dimension D1 and E1 do not include mold protrusion. Allowable protrusion is .101" (.25mm)
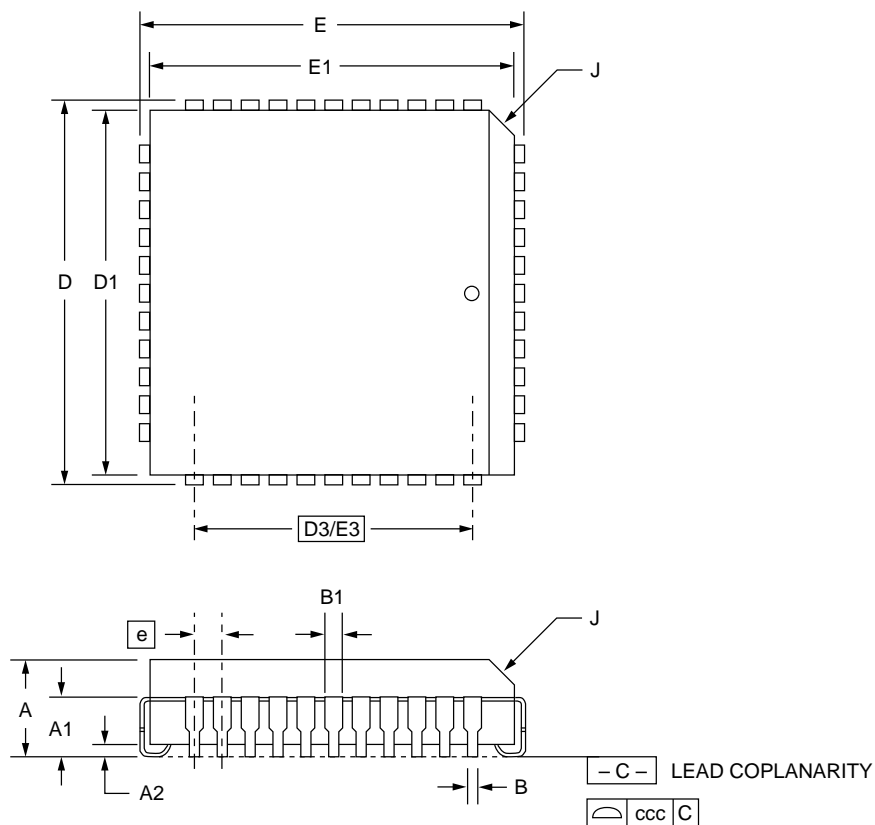
Preliminary Information

Ordering Information

Product Number	Temperature Range	Screening	Package	Package Marking
TMC2490R2C	0°C to 70°C	Commercial	44-Lead PLCC	2490R2C

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